

## 1. Product Features

### 1.1 Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=450A / I_{CRM}=900A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- Integrated NTC temperature sensor
- High power and thermal cycling capability



Figure1 IGBT Module

### 1.2 Mechanical features

- Integrated NTC temperature sensor
- High power and thermal cycling capability
- $Al_2O_3$  substrate with low thermal resistance
- Copper base plate

## 2. Typical Applications

- Switching mode power supply
- Drive inverters with brake system
- Uninterruptible power supply
- AC and DC servo drive amplifier

## 3. Description

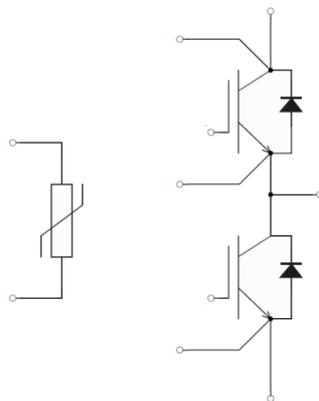


Figure 2 Half Bridge

## 4. IGBT, Inverter

### 4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj, max} = 150^{\circ}\text{C}$	$I_{C nom}$	450	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1 \text{ ms}$	$I_{CRM}$	900	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj, max} = 150^{\circ}\text{C}$	$P_{tot}$	1150	W
Gate-emitter peak voltage 栅极—发射极峰值电压		$V_{GES}$	+/- 20	V

### 4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 450 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE, sat}$		$T_{vj} = 25^{\circ}\text{C}$	1.5	1.9	V
				$T_{vj} = 125^{\circ}\text{C}$	1.8		V
				$T_{vj} = 150^{\circ}\text{C}$	1.9		V
Gate threshold voltage 栅极阈值电压	$I_C = 17.1 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, th}$	5.0	6.0	6.5	V	
Gate charge 栅极电荷	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	$Q_G$		1.7		$\mu\text{C}$	
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	$R_{Gint}$		2.1		$\Omega$	
Input capacitance 输入电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	$C_{ies}$		21.6		nF	
Reverse transfer capacitance 反向传输电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	$C_{res}$		0.17		nF	
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{CES}$			3	mA	
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{GES}$			300	nA	
Turn-on delay time, inductive load 开通延迟时间	$I_C = 450 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, on} = 2.2 \Omega$	$t_{d, on}$		$T_{vj} = 25^{\circ}\text{C}$	0.23		us
				$T_{vj} = 125^{\circ}\text{C}$	0.23		us
				$T_{vj} = 150^{\circ}\text{C}$	0.23		us
Rise time, inductive load 上升时间	$I_C = 450 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, on} = 2.2 \Omega$	$t_r$		$T_{vj} = 25^{\circ}\text{C}$	0.13		us
				$T_{vj} = 125^{\circ}\text{C}$	0.15		us
				$T_{vj} = 150^{\circ}\text{C}$	0.15		us

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Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Turn-off delay time, inductive load 关断延迟时间	$I_C = 450A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 2.2\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$t_{d,off}$		0.54		us
					0.58		us
					0.60		us
Fall time, inductive load 下降时间	$I_C = 450A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 2.2\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$t_f$		0.16		us
					0.28		us
					0.31		us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 450A, V_{CE} = 600V, L_s = 35nH$ $V_{GE} = +15/-15V, di/dt = 2300A/\mu s$ $R_{G,on} = 2.2\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$E_{on}$		25.5		mJ
					40.0		mJ
					45.0		mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 450A, V_{CE} = 600V, L_s = 35nH$ $V_{GE} = +15/-15V, dv/dt = 3400V/\mu s$ $R_{G,off} = 2.2\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$E_{off}$		36.2		mJ
					52.0		mJ
					56.0		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$		$I_{sc}$		2100		A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT		$R_{th,jc}$			0.095	K/W

## 5. Diode, Inverter

### 5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	$V_{RRM}$	1200	V
Continuous DC forward current 连续正向直流电流		$I_F$	450	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1\text{ ms}$	$I_{FRM}$	900	A

### 5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 450A, V_{GE} = 0V$	$V_F$		2.00	2.40	V
				1.70		V
				1.60		V

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Parameter	Note or test condition		Symbol	Values			Unit
				Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 450A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 3000 A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj} = 25^\circ C$	$I_{RM}$		230		A
		$T_{vj} = 125^\circ C$			380		A
		$T_{vj} = 150^\circ C$			412		A
Recovered charge 恢复电荷	$I_F = 450A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 3000 A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj} = 25^\circ C$	$Q_r$		24.5		$\mu C$
		$T_{vj} = 125^\circ C$			65.4		$\mu C$
		$T_{vj} = 150^\circ C$			79.8		$\mu C$
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 450A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 3000 A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj} = 25^\circ C$	$E_{rec}$		2.6		mJ
		$T_{vj} = 125^\circ C$			10.6		mJ
		$T_{vj} = 150^\circ C$			15.3		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode		$R_{th,Jc}$			0.12	K/W

## 6. NTC-Thermistor

### 6.1 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance 额定电阻值	$T_c = 25^\circ C$	$R_{25}$		5.00		K $\Omega$
Power dissipation 耗散功耗	$T_c = 25^\circ C$	$P_{25}$			20	mW
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298, 15K))]$	$B_{25}/B_{50}$		3375		K
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/75}(1/T_2-1/(298, 15K))]$	$B_{25}/B_{75}$		3408		K
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298, 15K))]$	$B_{25}/B_{100}$		3436		K

## 7. Module

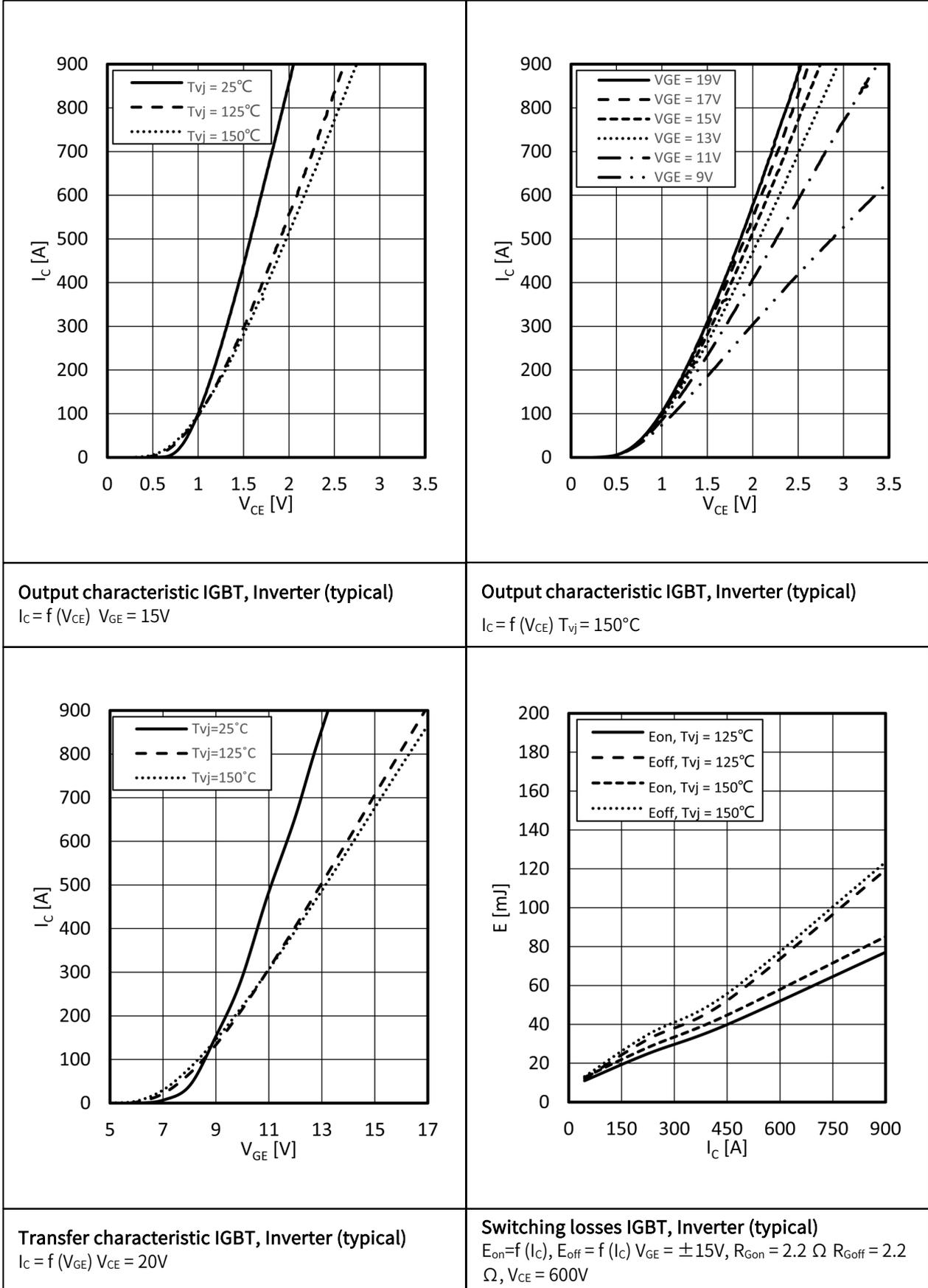
### 7.1 Characteristic value

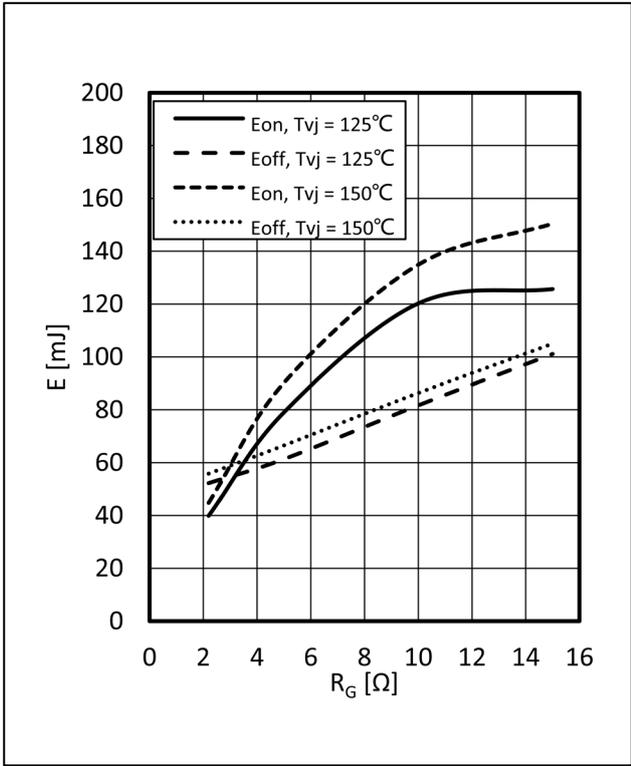
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	$V_{ISOL}$			2500	V
Stray inductance module 杂散电感		$L_{SCE}$		35		nH

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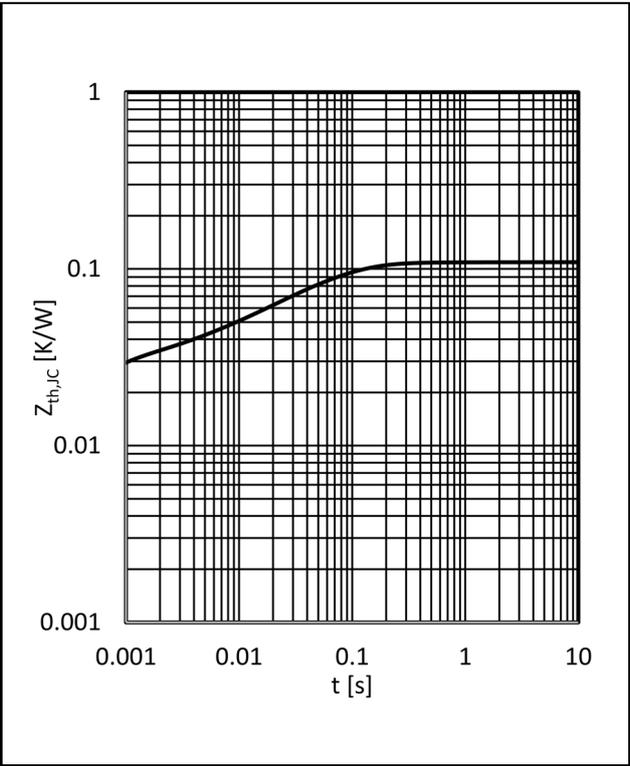
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Operation Junction Temperature 结温		$T_{jop}$	-40		150	°C
Storage Temperature Range 存储温度范围		$T_{stg}$	-40		125	°C
Mounting Torque 安装扭矩	Screw M5	M	3		6	N.m
Weight of Module 重量		G		350		g

## 8. Characteristics diagrams

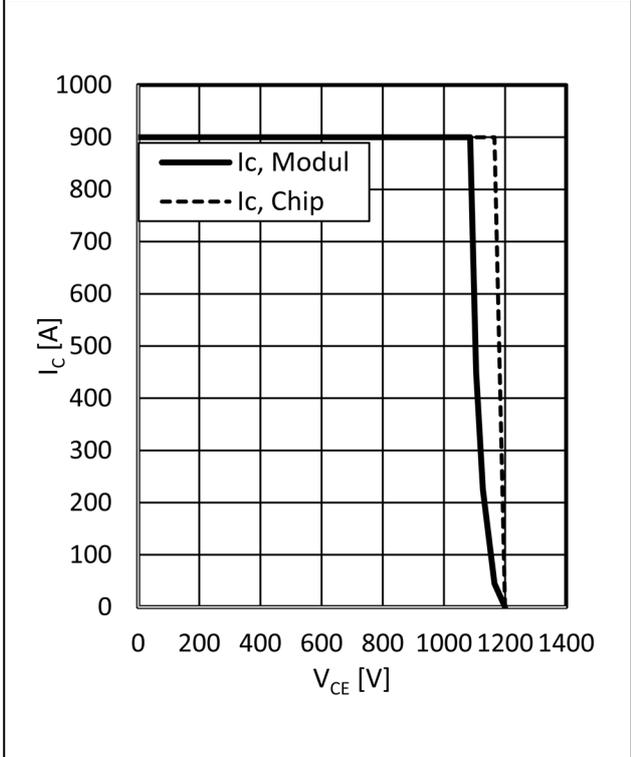




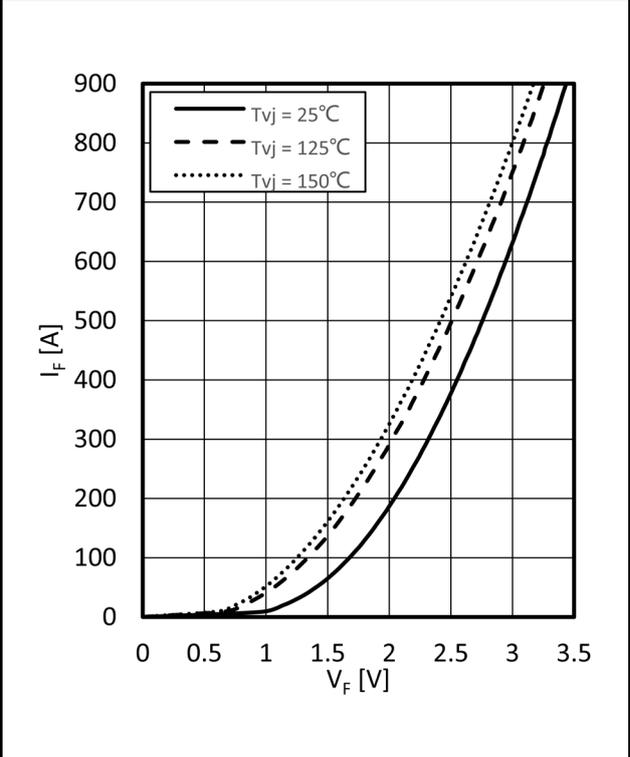
**Switching losses IGBT, Inverter (typical)**  
 $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   $V_{GE} = \pm 15V$ ,  $I_c = 450A$ ,  $V_{CE} = 600V$



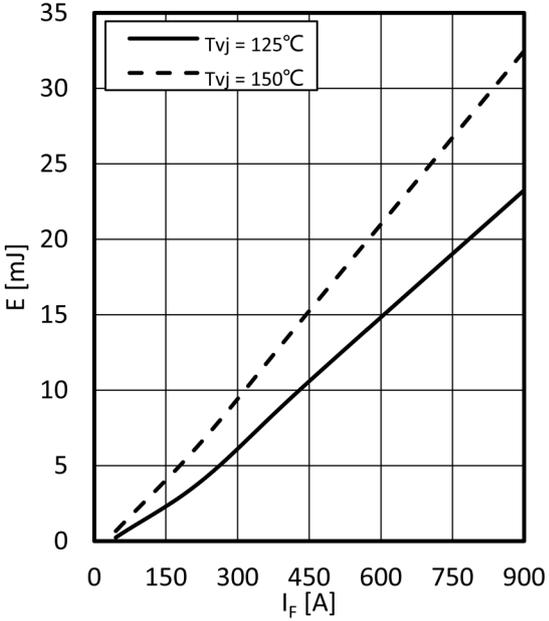
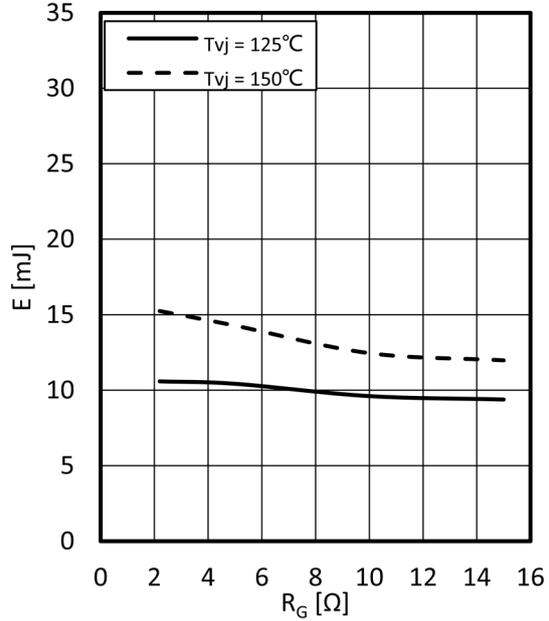
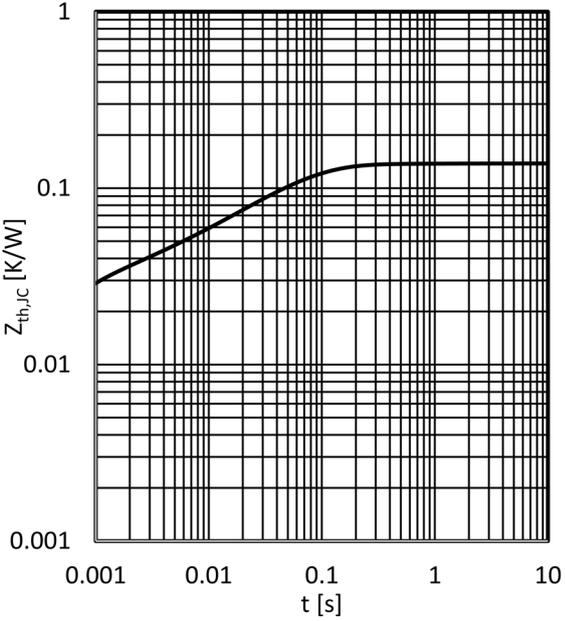
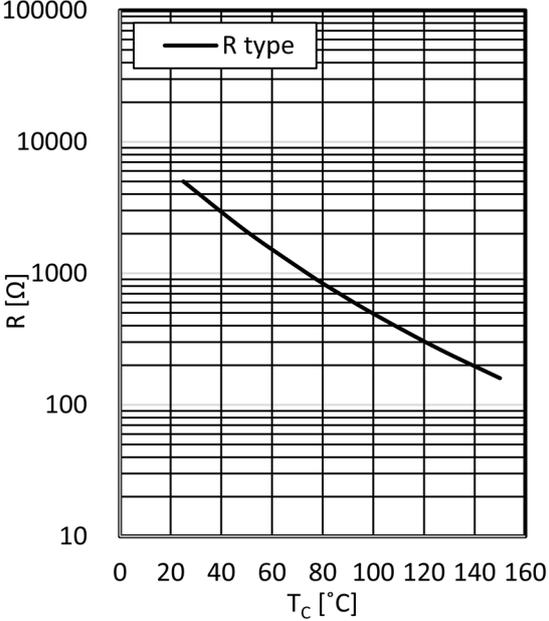
**Transient thermal impedance IGBT, Inverter**  
 $Z_{th,jc} = f(t)$



**Reverse bias safe operating area IGBT, Inverter (RBSOA)**  
 $I_c = f(V_{CE})$   $V_{GE} = \pm 15V$   $R_{Goff} = 2.2\Omega$ ,  $T_{vj} = 150^\circ\text{C}$



**Forward characteristic of Diode, Inverter (typical)**  
 $I_F = f(V_F)$

 <p>A line graph showing switching energy E [mJ] on the y-axis (0 to 35) versus forward current I<sub>F</sub> [A] on the x-axis (0 to 900). Two curves are shown: a solid line for T<sub>vj</sub> = 125°C and a dashed line for T<sub>vj</sub> = 150°C. Both curves show an increasing trend, with the 150°C curve being steeper and higher than the 125°C curve.</p>	 <p>A line graph showing switching energy E [mJ] on the y-axis (0 to 35) versus gate resistance R<sub>G</sub> [Ω] on the x-axis (0 to 16). Two curves are shown: a solid line for T<sub>vj</sub> = 125°C and a dashed line for T<sub>vj</sub> = 150°C. Both curves show a slight decreasing trend as R<sub>G</sub> increases, with the 150°C curve being higher than the 125°C curve.</p>
<p><b>Switching losses Diode, Inverter (typical)</b>  <math>E_{rec} = f(I_F) R_{Gon} = 2.2 \Omega, V_{CC} = 600V</math></p>	<p><b>Switching losses Diode, Inverter (typical)</b>  <math>E_{rec} = f(R_G) I_F = 450 A, V_{CC} = 600V</math></p>
 <p>A log-log plot showing transient thermal impedance Z<sub>th,jc</sub> [K/W] on the y-axis (0.001 to 1) versus time t [s] on the x-axis (0.001 to 10). The curve starts at approximately 0.03 K/W at 0.001 s and rises to a steady-state value of about 0.15 K/W after 0.1 s.</p>	 <p>A semi-log plot showing NTC-thermistor resistance R [Ω] on the y-axis (10 to 100,000) versus temperature T<sub>c</sub> [°C] on the x-axis (0 to 160). The curve, labeled 'R type', shows a decreasing trend from approximately 5,000 Ω at 20°C to about 150 Ω at 160°C.</p>
<p><b>Transient thermal impedance Diode Inverter</b>  <math>Z_{th,jc} = f(t)</math></p>	<p><b>NTC-Thermistor-temperature characteristic (typical)</b>  <math>R = f(T)</math></p>

### 9. Circuit Diagram

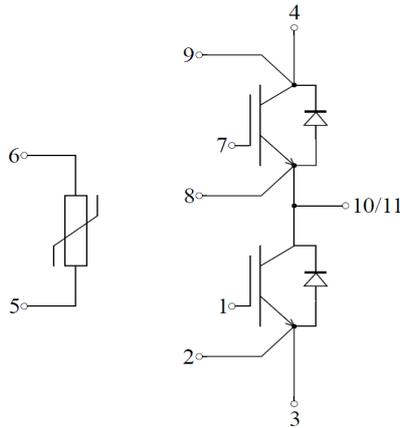


Figure 3

### 10. Package Outlines

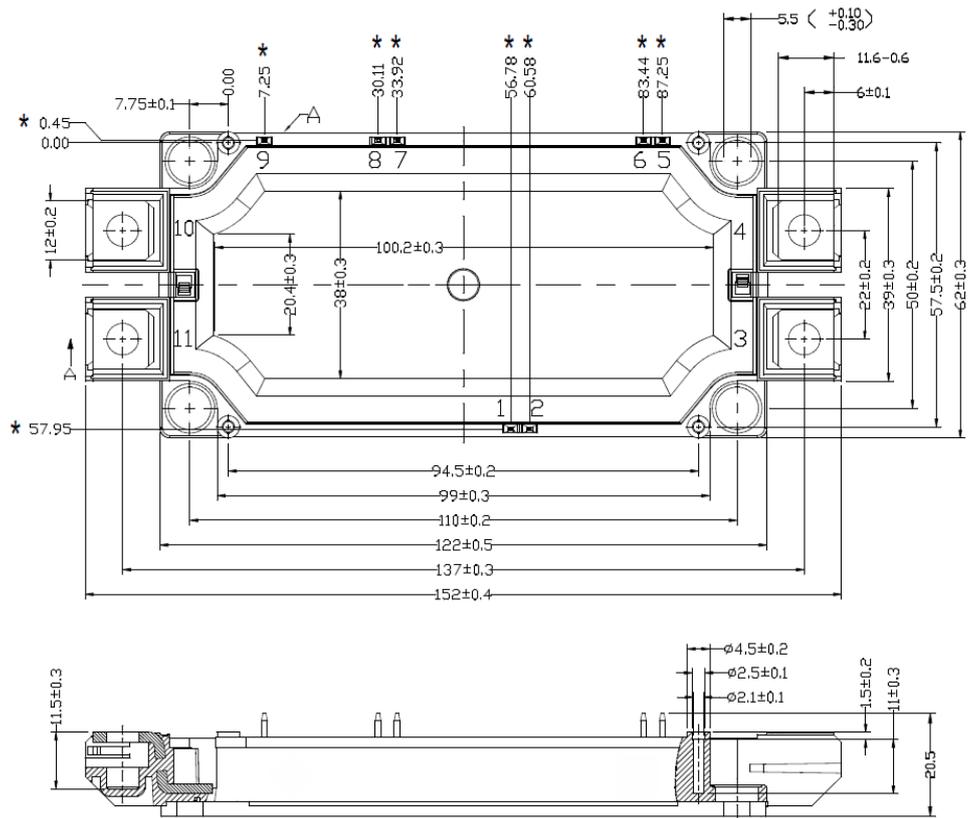


Figure 4